

Features :

- Isolated mounting base 2500V~
- Simple design, Module and SCR rectifier bridge,
Small volume, light weight

Typical Applications :

- Supplies for DC power equipment
- Field supply for DC motors
- Inverter welder

V_{DSM} / V_{RSM}	V_{DRM} / V_{RRM}	Type
900V	800V	MG75TH80S
1100V	1000V	MG75TH100S
1300V	1200V	MG75TH120S
1500V	1400V	MG75TH140S
1700V	1600V	MG75TH160S
1900V	1800V	MG75TH180S

Diode

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T_j (°C)	VALUE			UNIT
				Min	Type	Max	
I_D	DC output current	Three-phase full wave rectifying circuit, $T_C=100^\circ\text{C}$	125			75	A
V_{RRM}	Repetitive peak reverse voltage	$t_p=10\text{ms}$	125	600		1800	V
I_{RRM}	Repetitive peak current	at V_{RRM}	125			8	mA
I_{FSM}	Surge forward current	10ms half sine wave	125			0.5	kA
I^2t	I^2t for fusing coordination	$V_R=0$				1.25	$\text{A}^2\text{s} \cdot 10^3$
V_{FO}	Threshold voltage		125			0.85	V
r_F	Forward slope resistance					3.1	$\text{m}\Omega$
V_{FM}	Peak forward voltage	$I_{FM}=75\text{A}$	25			1.25	V
$R_{th(j-c)}$	Thermal resistance Junction to case	Single side cooled, per chip				0.25	$^\circ\text{C} / \text{W}$
$R_{th(c-h)}$	Thermal resistance case to heatsink	Single side cooled, per chip				0.08	$^\circ\text{C} / \text{W}$
V_{iso}	Isolation voltage	50Hz, R.M.S, $t=1\text{min}$, $I_{iso}: 1\text{mA}(\text{max})$		2500			V
F_m	Terminal connection torque(M5)				4		N·m
	Mounting torque(M6)				6		N·m
T_{stg}	Stored temperature			-40		125	$^\circ\text{C}$
W_t	Weight				215		g
Outline	M32						

Thyristor

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T _j (°C)	VALUE			UNIT
				Min	Type	Max	
I _{T(AV)}	Mean on-state current	180° half sine wave 50Hz Single side cooled, T _c =100°C	125			75	A
V _{DRM} V _{RRM}	Repetitive peak off-state voltage Repetitive peak reverse voltage	tp=10ms	125	600		1800	V
I _{DRM} I _{RRM}	Repetitive peak current	at V _{DRM} at V _{RRM}	125			15	mA
I _{TSM}	Surge on-state current	10ms half sine wave	125			0.5	kA
I ² t	I ² t for fusing coordination	V _R =60%V _{RRM}				1.25	A ² s*10 ³
V _{TO}	Threshold voltage		125			0.85	V
r _T	On-state slope resistance					3.1	mΩ
I _{GT}	Gate trigger current		25	30		200	mA
V _{GT}	Gate trigger voltage	V _A =12V, I _A =1A		0.6		2.5	V
I _H	Holding current			10		250	mA
V _{TM}	Peak on-state voltage	I _{TM} =230A				1.60	V
dv/dt	Critical rate of rise of off-state voltage	V _{DM} =67%V _{DRM}	125			500	V/μs
R _{th(j-c)}	Thermal resistance Junction to case	Single side cooled, per chip				0.40	°C/W
R _{th(c-h)}	Thermal resistance case to heatsink	Single side cooled, per chip				0.13	°C/W
V _{iso}	Isolation voltage	50Hz, R.M.S, t=1min, I _{iso} : 1mA(MAX)		2500			V
F _m	Terminal connection torque(M5)				4		N·m
	Mounting torque(M6)				6		N·m
T _{stg}	Stored temperature			-40		125	°C
W _t	Weight				215		g
Outline	M32						

Outline :

